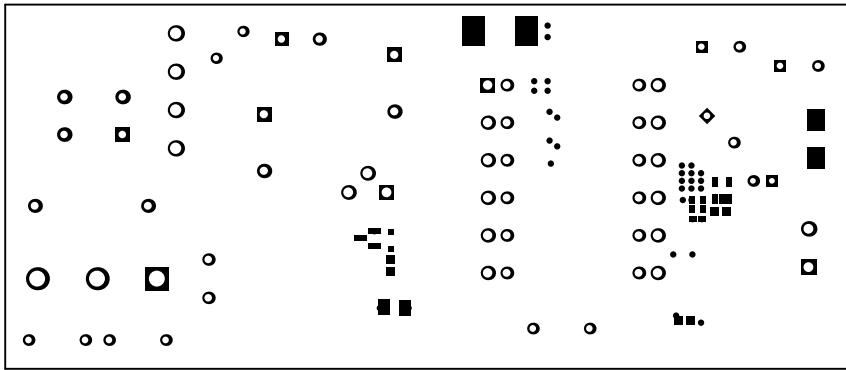
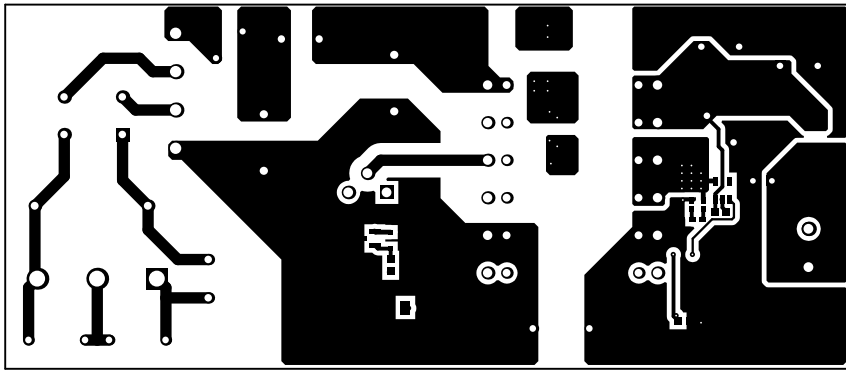


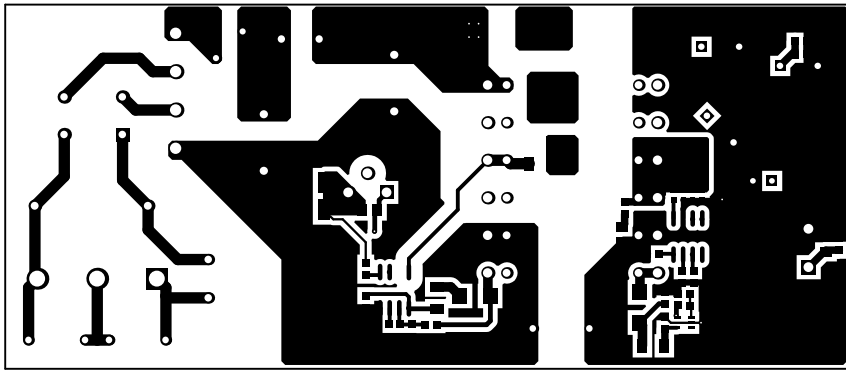
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10407	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 5/6/2015 12:16:07 AM	TEXAS INSTRUMENTS	



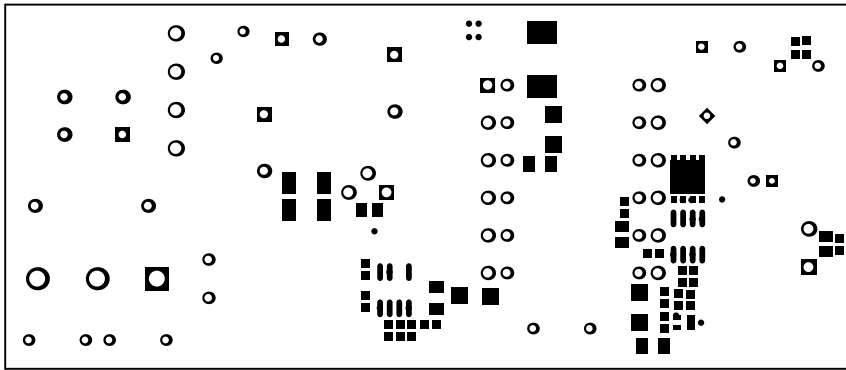
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10407	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 5/6/2015 12:16:09 AM	TEXAS INSTRUMENTS	



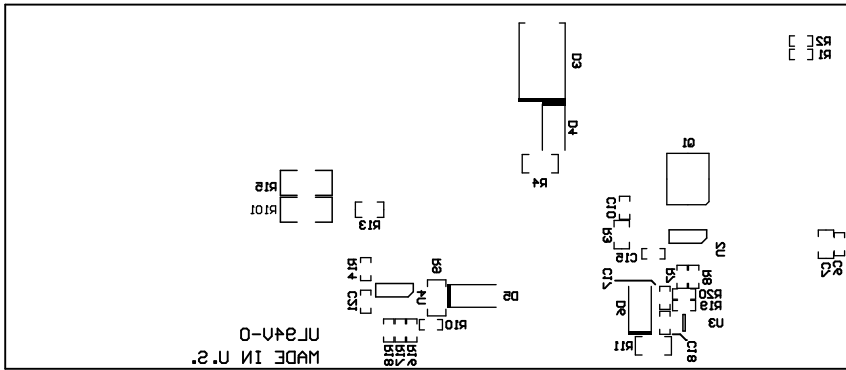
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10407	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 5/6/2015 12:16:11 AM	TEXAS INSTRUMENTS	



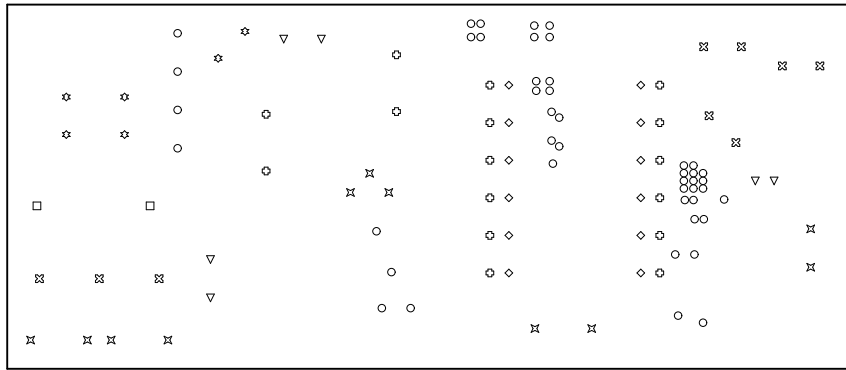
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10407	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 5/6/2015 12:16:13 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10407	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 5/6/2015 12:16:15 AM	TEXAS INSTRUMENTS	



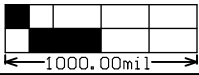
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10407	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 5/6/2015 12:16:17 AM	TEXAS INSTRUMENTS	



Symbol	Hit Count	Tool Size	Plated	Hole Type
○	41	10mil (0.254mm)	PTH	Round
▽	2	31mil (0.787mm)	PTH	Round
*	2	33.465mil (0.85mm)	PTH	Round
⊗	6	35mil (0.889mm)	PTH	Round
⊗	6	35.433mil (0.9mm)	PTH	Round
▽	4	39.37mil (1mm)	PTH	Round
*	4	40mil (1.016mm)	PTH	Round
◇	12	41.339mil (1.05mm)	PTH	Round
□	2	42.079mil (1.069mm)	PTH	Round
⊗	4	43.307mil (1.1mm)	PTH	Round
⊗	12	49.213mil (1.25mm)	PTH	Round
⊗	5	51.181mil (1.3mm)	PTH	Round
○	4	59.055mil (1.5mm)	PTH	Round
⊗	3	84.646mil (2.15mm)	PTH	Round
107 Total				

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10407	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 5/6/2015 12:16:19 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10407	REV: B	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 5/6/2015 12:16:22 AM	TEXAS INSTRUMENTS	

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